

40V N-Channel Enhancement Mode MOSFET

Voltage

40 V

Current

310 A

Features

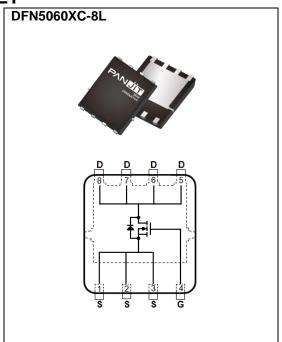
- RDS(ON), VGS@10V, ID@20A<1.1m Ω
- RDS(ON), VGS@7V, ID@20A<1.7m Ω
- Excellent FOM
- Standard Level Drive
- AEC-Q101 qualified
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

Mechanical Data

• Case: DFN5060XC-8L Package

• Terminals : Solderable per MIL-STD-750, Method 2026

• Approx. Weight: 0.098 grams



Maximum Ratings and Thermal Characteristics (T_A=25°C unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNITS	
Drain-Source Voltage		V _{DS}	40	V	
Gate-Source Voltage		V _{GS}	±20		
Continuous Drain Current(Note 3)	T _C =25°C		310		
	T _C =100°C	l _D	220	Α	
Pulsed Drain Current(Note 1)	Tc=25°C	I _{DM}	800	ļ	
Power Dissipation	Tc=25°C	D-	195	W	
	T _C =100°C	Po	97		
Continuous Drain Current(Note 4)	T _A =25°C	I _D	43.5	А	
	T _A =70°C		36.4		
Power Dissipation	T _A =25°C	Do	3.8	W	
	T _A =70°C	Pb	2.6		
Single Pulse Avalanche Current(Note 5)		las	27.3	Α	
Single Pulse Avalanche Energy ^(Note 5)		Eas	288	mJ	
Operating Junction and Storage Temperature Range		T _J ,T _{STG}	-55~175	°C	
Thermal Resistance ^(Note 4)	Junction to Case	R _{θJC}	0.77	°C/W	
	Junction to Ambient	R _{θJA}	40		



Electrical Characteristics (T_A=25°C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS	
Static							
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V, I _D =250uA	A 40				
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250uA	2	3	4	V	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} =10V, I _D =20A	-	0.88	1.1	mΩ	
		V _{GS} =7V, I _D =20A	-	1.32	1.7		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =40V, V _{GS} =0V	-	-	1	uA	
Gate-Source Leakage Current	I _{GSS}	V _{GS} =±20V, V _{DS} =0V	-	-	±100	nA	
Dynamic ^(Note 6)					•		
Total Gate Charge	Q_g	.,	-	80	106	nC	
Gate-Source Charge	Q_{gs}	V _{DS} =32V, I _D =20A,	-	15.5	-		
Gate-Drain Charge	Q_{gd}	V _{GS} =10V	-	8	-		
Input Capacitance	Ciss	\(\(\alpha\)	-	4419	5750	pF	
Output Capacitance	Coss	V _{DS} =25V, V _{GS} =0V,	-	1504	1960		
Reverse Transfer Capacitance	Crss	f=1MHz	-	91	160		
Gate resistance	Rg	f=1MHz	-	2.5	-	Ω	
Turn-On Delay Time	td _(on)		-	17	-	ns	
Turn-On Rise Time	tr	V _{DS} =32V, I _D =20A,	-	25	-		
Turn-Off Delay Time	td _(off)	$V_{GS}=10V, R_G=3\Omega$ (Note 2)	-	51	-		
Turn-Off Fall Time	t _f	(Note 2)	-	35	-		
Drain-Source Diode	•	1			•		
Diode Forward Current	Is	T _C =25°C	-	-	200	А	
Pulsed Diode Forward Current	I _{SM}	(Package Limit)	-	-	800		
Diode Forward Voltage	V _{SD}	Is=20A, V _{GS} =0V	-	0.76	1.3	V	
Reverse Recovery Time	Trr	V _{DD} =32V,V _{GS} =0V	-	65	-	ns	
Reverse Recovery Charge	Qrr	Is=20A,dIs/dt=100A/us	-	65	-	nC	

NOTES:

- 1. Pulse width<100us, Duty cycle<2%.
- 2. Essentially independent of operating temperature typical characteristics.
- 3. Chip capability with an $R_{\theta JC}$ =0.77°C/W, Package limited 100A.
- 4. R_{BJA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch² with 2oz.square pad of copper.
- 5. Eas is calculated based on the condition of L=1mH, Ias=24A, V_{DD}=30V, V_{GS}=10V. 100% test at L=0.5mH, Ias=27.3A in production.
- 6. Guaranteed by design, not subject to production testing.



TYPICAL CHARACTERISTIC CURVES

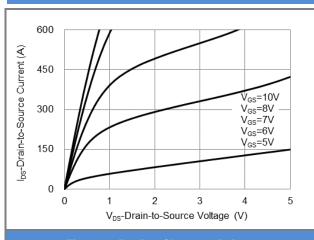


Fig.1 On-Region Characteristics

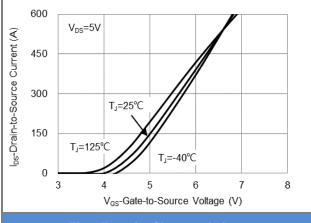


Fig.2 Transfer Characteristics

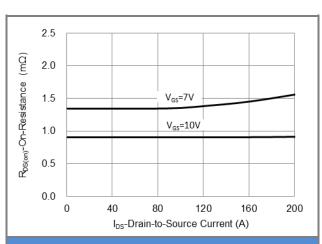


Fig.3 On-Resistance vs. Drain Current

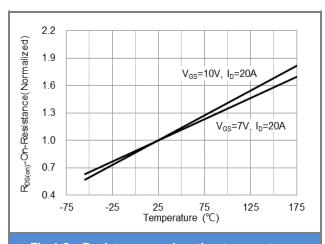
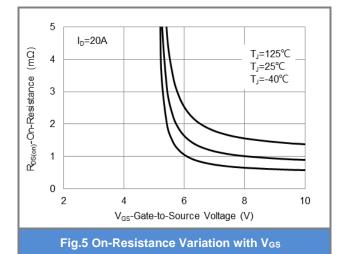


Fig.4 On-Resistance vs. Junction temperature



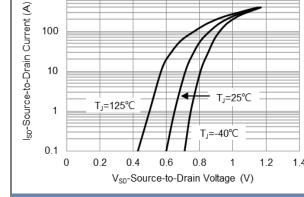


Fig.6 Source-Drain Diode Forward Voltage

1000

100

10



TYPICAL CHARACTERISTIC CURVES

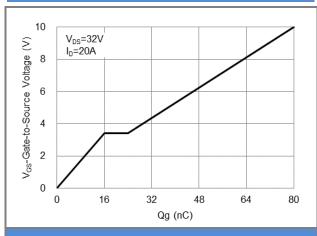


Fig.7 Gate-Charge Characteristics

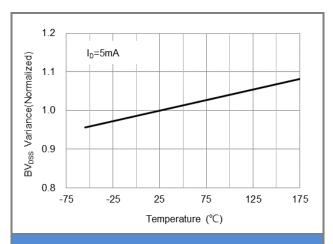


Fig.8 Breakdown Voltage Variation vs. Temperature

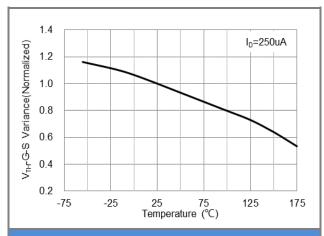


Fig.9 Threshold Voltage Variation with Temperature

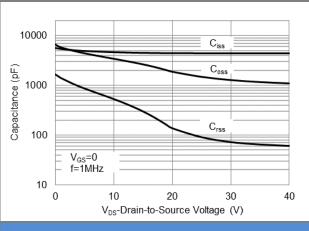
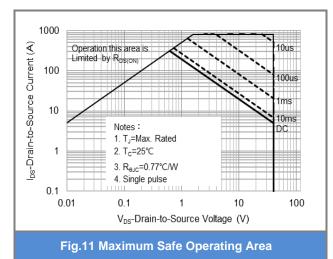


Fig.10 Capacitance vs. Drain-Source Voltage



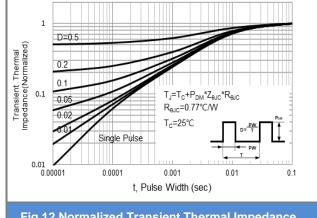


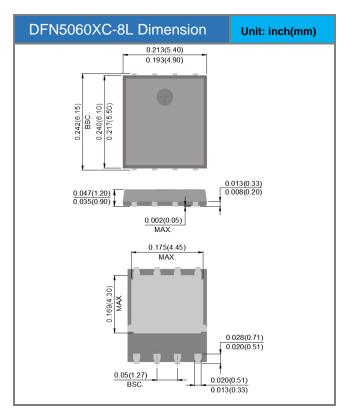
Fig.12 Normalized Transient Thermal Impedance

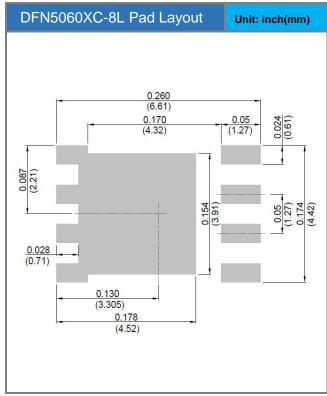


Product and Packing Information

Part No.	Package Type	Packing Type	Marking
PJQ5538S6VC-AU	DFN5060XC-8L	3K pcs / 13" reel	538S6VC

Packaging Information & Mounting Pad Layout







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